

# **4V Drive Pch MOSFET**

# RQ1E070RP

#### Structure

Silicon P-channel MOSFET

#### ● Features

- 1) Low On-resistance.
- 2) High power package.
- 3) 4V drive.

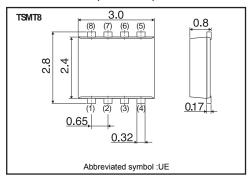
### Application

Switching

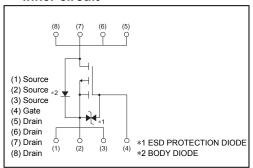
Packaging specifications

	Package	Taping	
Type	Code	TR	
	Basic ordering unit (pieces)	3000	
RQ1E070F	0		

#### Dimensions (Unit : mm)



#### • Inner circuit



## ● Absolute maximum ratings (Ta = 25°C)

Parame	Symbol	Limits	Unit	
Drain-source voltage		$V_{DSS}$	-30	V
Gate-source voltage		$V_{GSS}$	<u>+2</u> 0	V
Drain current	Continuous	I <sub>D</sub>	±7	Α
	Pulsed	I <sub>DP</sub> *1	±28	Α
Source current	Continuous	Is	-1	Α
(Body Diode)	Pulsed	I <sub>SP</sub> *1	-28	Α
Power dissipation		P <sub>D</sub> *2	1.5	W
Channel temperature		Tch	150	°C
Range of storage temperature		Tstg	-55 to +150	°C

<sup>\*1</sup> Pw $\leq$ 10 $\mu$ s, Duty cycle $\leq$ 1%

#### Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to Ambient	Rth (ch-a)*	83.3	°C / W

<sup>\*</sup>Mounted on a ceramic board.

<sup>\*2</sup> Mounted on a ceramic board.

# ● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	$I_{GSS}$	-	-	±10	μ <b>A</b>	$V_{GS}=\pm20V$ , $V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	-30	-	-	V	$I_D$ =-1mA, $V_{GS}$ =0V
Zero gate voltage drain current	I <sub>DSS</sub>	ı	1	-1	μA	$V_{DS}$ =-30V, $V_{GS}$ =0V
Gate threshold voltage	V <sub>GS (th)</sub>	-1.0	1	-2.5	V	$V_{DS}$ =-10V, $I_{D}$ =-1mA
2	*	ı	12	17		I <sub>D</sub> =-7A, V <sub>GS</sub> =-10V
Static drain-source on-state resistance	R <sub>DS (on)</sub>	ı	17	24	mΩ	$I_D = -3.5A, V_{GS} = -4.5V$
		ı	19	27		$I_D = -3.5A, V_{GS} = -4.0V$
Forward transfer admittance	IY <sub>fs</sub> ľ	6	1	-	S	I <sub>D</sub> =-7A, V <sub>DS</sub> =-10V
Input capacitance	C <sub>iss</sub>	ı	2700	-	pF	V <sub>DS</sub> =-10V
Output capacitance	C <sub>oss</sub>	1	390	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	C <sub>rss</sub>	1	350	-	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> *	1	16	-	ns	I <sub>D</sub> =-3.5A, V <sub>DD</sub> ≒-15V
Rise time	t <sub>r</sub> *	ı	35	-	ns	V <sub>GS</sub> =-10V
Turn-off delay time	t <sub>d(off)</sub> *	ı	140	-	ns	R <sub>L</sub> ≒4.3Ω
Fall time	t <sub>f</sub> *	ı	70	-	ns	$R_G$ =10 $\Omega$
Total gate charge	Q <sub>g</sub> *	-	26	-	nC	I <sub>D</sub> =-7A, V <sub>DD</sub> ≒-15V
Gate-source charge	Q <sub>gs</sub> *	-	7.5	-	nC	V <sub>GS</sub> =–5V R <sub>L</sub> ≒ 2.1Ω
Gate-drain charge	Q <sub>gd</sub> *	-	8.0	-	nC	$R_G$ =10 $\Omega$

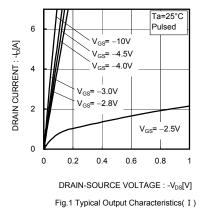
<sup>\*</sup>Pulsed

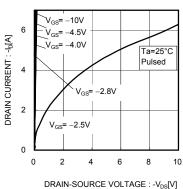
# ●Body diode characteristics (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward Voltage	V <sub>SD</sub> *	-	-	-1.2	V	I <sub>s</sub> =-7A, V <sub>GS</sub> =0V

<sup>\*</sup>Pulsed

#### Electrical characteristic curves





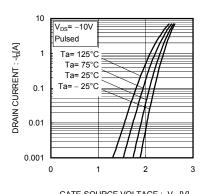


Fig.2 Typical Output Characteristics( II )

GATE-SOURCE VOLTAGE : -V<sub>GS</sub>[V]
Fig.3 Typical Transfer Characteristics

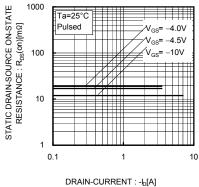


Fig.4 Static Drain-Source On-State
Resistance vs. Drain Current( I )

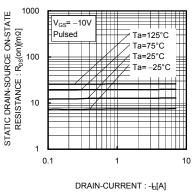


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current( II )

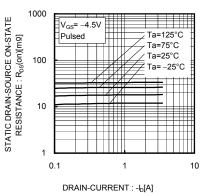


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)

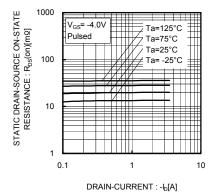
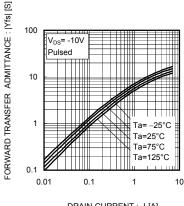
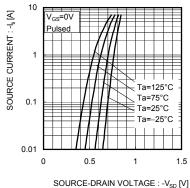


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(IV)



DRAIN-CURRENT : -[b[A]
Fig.8 Forward Transfer Admittance
vs. Drain Current



SOURCE-DRAIN VOLTAGE: -V<sub>SD</sub> [V Fig.9 Reverse Drain Current vs. Sourse-Drain Voltage

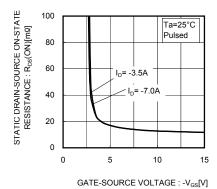


Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

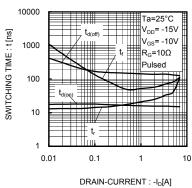


Fig.11 Switching Characteristics

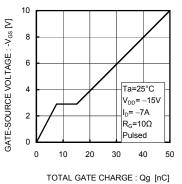
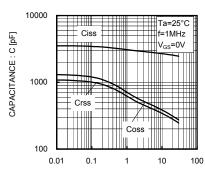


Fig.12 Dynamic Input Characteristics



DRAIN-SOURCE VOLTAGE : -V<sub>DS</sub>[V]
Fig.13 Typical Capacitance
vs. Drain-Source Voltage

# Measurement circuits

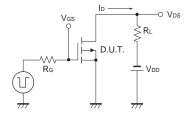


Fig.1-1 Switching time measurement circuit

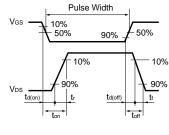


Fig.1-2 Switching Waveforms

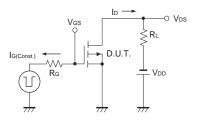


Fig.2-1 Gate charge measurement circuit

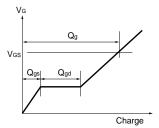


Fig.2-2 Gate Charge Waveform

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